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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	M16C/60
Core Size	16-Bit
Speed	24MHz
Connectivity	I <sup>2</sup> C, IEBus, UART/USART
Peripherals	DMA, WDT
Number of I/O	50
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/m30622sppg-u3c">https://www.e-xfl.com/product-detail/renesas-electronics-america/m30622sppg-u3c</a>

**Table 1.3 Performance Outline of M16C/62P Group (M16C/62P, M16C/62PT)(80-pin version)**

	Item	Performance	
		M16C/62P	M16C/62PT <sup>(4)</sup>
CPU	Number of Basic Instructions	91 instructions	
	Minimum Instruction Execution Time	41.7ns(f(BCLK)=24MHz, VCC1=3.3 to 5.5V) 100ns(f(BCLK)=10MHz, VCC1=2.7 to 5.5V)	41.7ns(f(BCLK)=24MHz, VCC1=4.0 to 5.5V)
	Operating Mode	Single-chip mode	
	Address Space	1 Mbyte	
	Memory Capacity	See <b>Table 1.4 to 1.7 Product List</b>	
Peripheral Function	Port	Input/Output : 70 pins, Input : 1 pin	
	Multifunction Timer	Timer A : 16 bits x 5 channels (Timer A1 and A2 are internal timer), Timer B : 16 bits x 6 channels (Timer B1 is internal timer)	
	Serial Interface	2 channels Clock synchronous, UART, I <sup>2</sup> C bus <sup>(1)</sup> , IEBus <sup>(2)</sup> 1 channel Clock synchronous, I <sup>2</sup> C bus <sup>(1)</sup> , IEBus <sup>(2)</sup> 2 channels Clock synchronous (1 channel is only transmission)	
	A/D Converter	10-bit A/D converter: 1 circuit, 26 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	2 channels	
	CRC Calculation Circuit	CCITT-CRC	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	Internal: 29 sources, External: 5 sources, Software: 4 sources, Priority level: 7 levels	
	Clock Generation Circuit	4 circuits Main clock generation circuit (*), Subclock generation circuit (*), On-chip oscillator, PLL synthesizer (* )Equipped with a built-in feedback resistor.	
	Oscillation Stop Detection Function	Stop detection of main clock oscillation, re-oscillation detection function	
	Voltage Detection Circuit	Available (option <sup>(4)</sup> )	Absent
	Electric Characteristics	Supply Voltage	VCC1=3.0 to 5.5 V, (f(BCLK)=24MHz) VCC1=2.7 to 5.5 V, (f(BCLK)=10MHz)
Power Consumption		14 mA (VCC1=5V, f(BCLK)=24MHz) 8 mA (VCC1=3V, f(BCLK)=10MHz) 1.8μA (VCC1=3V, f(XCIN)=32kHz, wait mode) 0.7μA (VCC1=3V, stop mode)	14 mA (VCC1=5V, f(BCLK)=24MHz) 2.0μA (VCC1=5V, f(XCIN)=32kHz, wait mode) 0.8μA (VCC1=5V, stop mode)
Flash memory version	Program/Erase Supply Voltage	3.3 ± 0.3V or 5.0 ± 0.5V	5.0 ± 0.5V
	Program and Erase Endurance	100 times (all area) or 1,000 times (user ROM area without block A and block 1) / 10,000 times (block A, block 1) <sup>(3)</sup>	
Operating Ambient Temperature	-20 to 85°C, -40 to 85°C <sup>(3)</sup>	T version : -40 to 85°C V version : -40 to 125°C	
Package	80-pin plastic mold QFP		

## NOTES:

- I<sup>2</sup>C bus is a registered trademark of Koninklijke Philips Electronics N. V.
- IEBus is a registered trademark of NEC Electronics Corporation.
- See **Table 1.8 and 1.9 Product Code** for the program and erase endurance, and operating ambient temperature.  
In addition 1,000 times/10,000 times are under development as of Jul., 2005. Please inquire about a release schedule.
- All options are on request basis.

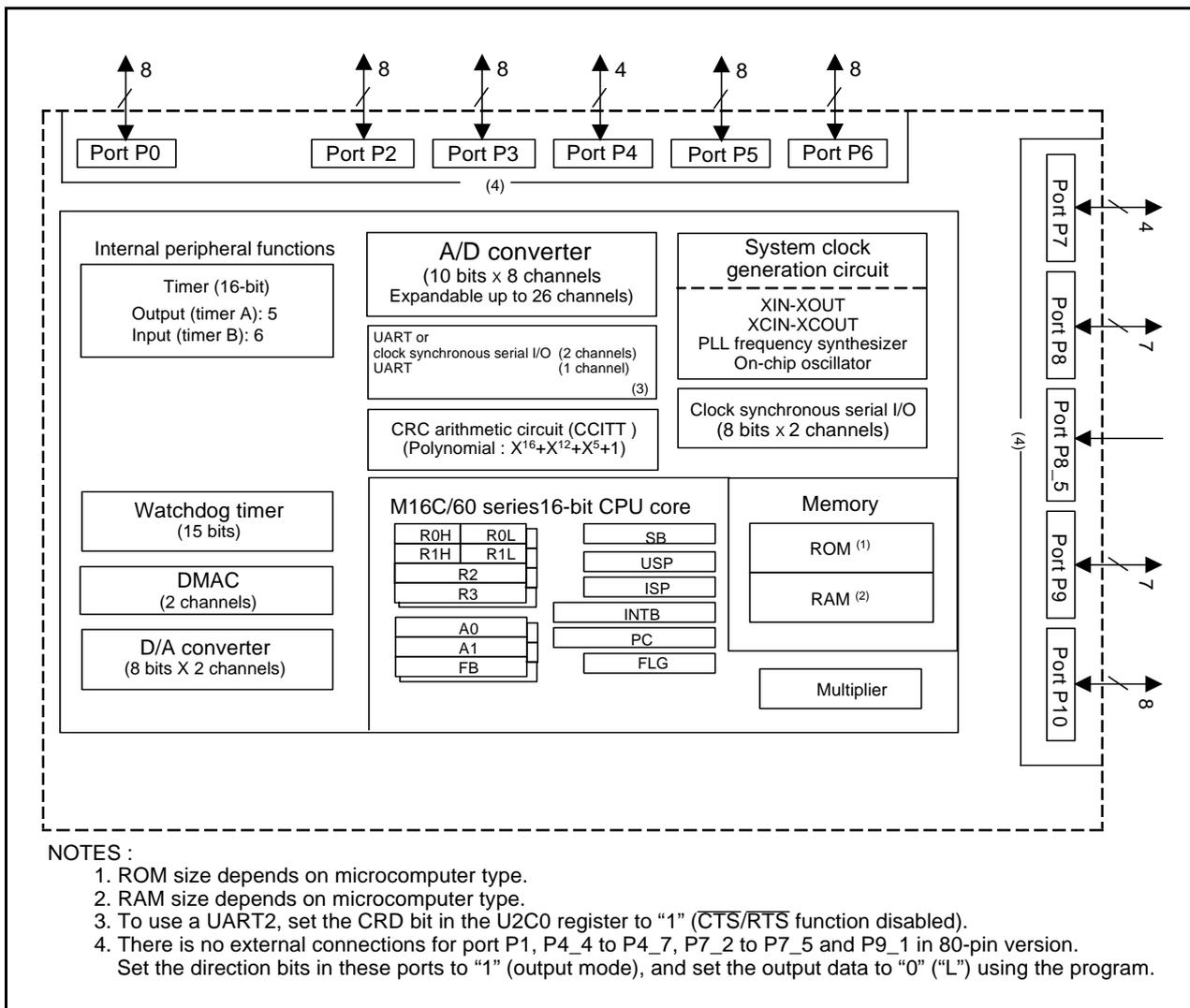


Figure 1.2 M16C/62P Group (M16C/62P, M16C/62PT) 80-pin version Block Diagram

**Table 1.6 Product List (3) (T version (M16C/62PT)) As of Dec. 2005**

Type No.	ROM Capacity	RAM Capacity	Package Type (1)	Remarks		
M3062CM6T-XXXFP (D)	48 Kbytes	4 Kbytes	PRQP0100JB-A	Mask ROM version	T Version (High reliability 85°C version)	
M3062CM6T-XXXGP (D)			PLQP0100KB-A			
M3062EM6T-XXXGP (P)			PRQP0080JA-A			
M3062CM8T-XXXFP (D)	64 Kbytes	4 Kbytes	PRQP0100JB-A			
M3062CM8T-XXXGP (D)			PLQP0100KB-A			
M3062EM8T-XXXGP (P)			PRQP0080JA-A			
M3062CMAT-XXXFP (D)	96 Kbytes	5 Kbytes	PRQP0100JB-A			
M3062CMAT-XXXGP (D)			PLQP0100KB-A			
M3062EMAT-XXXGP (P)			PRQP0080JA-A			
M3062AMCT-XXXFP (D)	128 Kbytes	10 Kbytes	PRQP0100JB-A			
M3062AMCT-XXXGP (D)			PLQP0100KB-A			
M3062BMCT-XXXGP (P)			PRQP0080JA-A			
M3062CF8TFP (D)	64 K+4 Kbytes	4 Kbytes	PRQP0100JB-A			Flash memory version (2)
M3062CF8TGP			PLQP0100KB-A			
M3062AFCTFP (D)	128K+4 Kbytes	10 Kbytes	PRQP0100JB-A			
M3062AFCTGP (D)			PLQP0100KB-A			
M3062BFCTGP (P)			PRQP0080JA-A			
M3062JFHTFP (D)	384K+4 Kbytes	31 Kbytes	PRQP0100JB-A			
M3062JFHTGP (D)			PLQP0100KB-A			

(D): Under development

(P): Under planning

## NOTES:

- The old package type numbers of each package type are as follows.  
PRQP0100JB-A : 100P6S-A,  
PLQP0100KB-A : 100P6Q-A,  
PRQP0080JA-A : 80P6S-A
- In the flash memory version, there is 4K bytes area (block A).

**Table 1.7 Product List (4) (V version (M16C/62PT)) As of Dec. 2005**

Type No.	ROM Capacity	RAM Capacity	Package Type <sup>(1)</sup>	Remarks		
M3062CM6V-XXXFP (P)	48 Kbytes	4 Kbytes	PRQP0100JB-A	Mask ROM version	V Version (High reliability 125°C version)	
M3062CM6V-XXXGP (P)			PLQP0100KB-A			
M3062EM6V-XXXGP (P)			PRQP0080JA-A			
M3062CM8V-XXXFP (P)	64 Kbytes	4 Kbytes	PRQP0100JB-A			
M3062CM8V-XXXGP (P)			PLQP0100KB-A			
M3062EM8V-XXXGP (P)			PRQP0080JA-A			
M3062CMAV-XXXFP (P)	96 Kbytes	5 Kbytes	PRQP0100JB-A			
M3062CMAV-XXXGP (P)			PLQP0100KB-A			
M3062EMAV-XXXGP (P)			PRQP0080JA-A			
M3062AMCV-XXXFP (D)	128 Kbytes	10 Kbytes	PRQP0100JB-A			Flash memory version <sup>(2)</sup>
M3062AMCV-XXXGP (D)			PLQP0100KB-A			
M3062BMCV-XXXGP (P)			PRQP0080JA-A			
M3062AFCVFP (D)	128K+4 Kbytes	10 Kbytes	PRQP0100JB-A			
M3062AFCVGP (D)			PLQP0100KB-A			
M3062BFCVGP (P)			PRQP0080JA-A			
M3062JFHVFP (P)	384K+4 Kbytes	31 Kbytes	PRQP0100JB-A			
M3062JFHVGP (P)			PLQP0100KB-A			

(D): Under development

(P): Under planning

## NOTES:

- The old package type numbers of each package type are as follows.  
 PLQP0128KB-A : 128P6Q-A,  
 PRQP0100JB-A : 100P6S-A,  
 PLQP0100KB-A : 100P6Q-A,  
 PRQP0080JA-A : 80P6S-A
- In the flash memory version, there is 4K bytes area (block A).

**Table 1.11 Pin Characteristics for 128-Pin Package (2)**

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	Bus Control Pin
51		P5_6					ALE
52		P5_5					$\overline{\text{HOLD}}$
53		P5_4					$\overline{\text{HLDA}}$
54		P13_3					
55		P13_2					
56		P13_1					
57		P13_0					
58		P5_3					BCLK
59		P5_2					$\overline{\text{RD}}$
60		P5_1					$\overline{\text{WRH/BHE}}$
61		P5_0					$\overline{\text{WRL/WR}}$
62		P12_7					
63		P12_6					
64		P12_5					
65		P4_7					$\overline{\text{CS3}}$
66		P4_6					$\overline{\text{CS2}}$
67		P4_5					$\overline{\text{CS1}}$
68		P4_4					$\overline{\text{CS0}}$
69		P4_3					A19
70		P4_2					A18
71		P4_1					A17
72		P4_0					A16
73		P3_7					A15
74		P3_6					A14
75		P3_5					A13
76		P3_4					A12
77		P3_3					A11
78		P3_2					A10
79		P3_1					A9
80		P12_4					
81		P12_3					
82		P12_2					
83		P12_1					
84		P12_0					
85	VCC2						
86		P3_0					A8(/-D7)
87	VSS						
88		P2_7				AN2_7	A7(/D7/D6)
89		P2_6				AN2_6	A6(/D6/D5)
90		P2_5				AN2_5	A5(/D5/D4)
91		P2_4				AN2_4	A4(/D4/D3)
92		P2_3				AN2_3	A3(/D3/D2)
93		P2_2				AN2_2	A2(/D2/D1)
94		P2_1				AN2_1	A1(/D1/D0)
95		P2_0				AN2_0	A0(/D0/-)
96		P1_7	$\overline{\text{INT5}}$				D15
97		P1_6	$\overline{\text{INT4}}$				D14
98		P1_5	$\overline{\text{INT3}}$				D13
99		P1_4					D12
100		P1_3					D11

**Table 1.12 Pin Characteristics for 128-Pin Package (3)**

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	Bus Control Pin
101		P1_2					D10
102		P1_1					D9
103		P1_0					D8
104		P0_7				AN0_7	D7
105		P0_6				AN0_6	D6
106		P0_5				AN0_5	D5
107		P0_4				AN0_4	D4
108		P0_3				AN0_3	D3
109		P0_2				AN0_2	D2
110		P0_1				AN0_1	D1
111		P0_0				AN0_0	D0
112		P11_7					
113		P11_6					
114		P11_5					
115		P11_4					
116		P11_3					
117		P11_2					
118		P11_1					
119		P11_0					
120		P10_7	$\overline{KI3}$			AN7	
121		P10_6	$\overline{KI2}$			AN6	
122		P10_5	$\overline{KI1}$			AN5	
123		P10_4	$\overline{KI0}$			AN4	
124		P10_3				AN3	
125		P10_2				AN2	
126		P10_1				AN1	
127	AVSS						
128		P10_0				AN0	

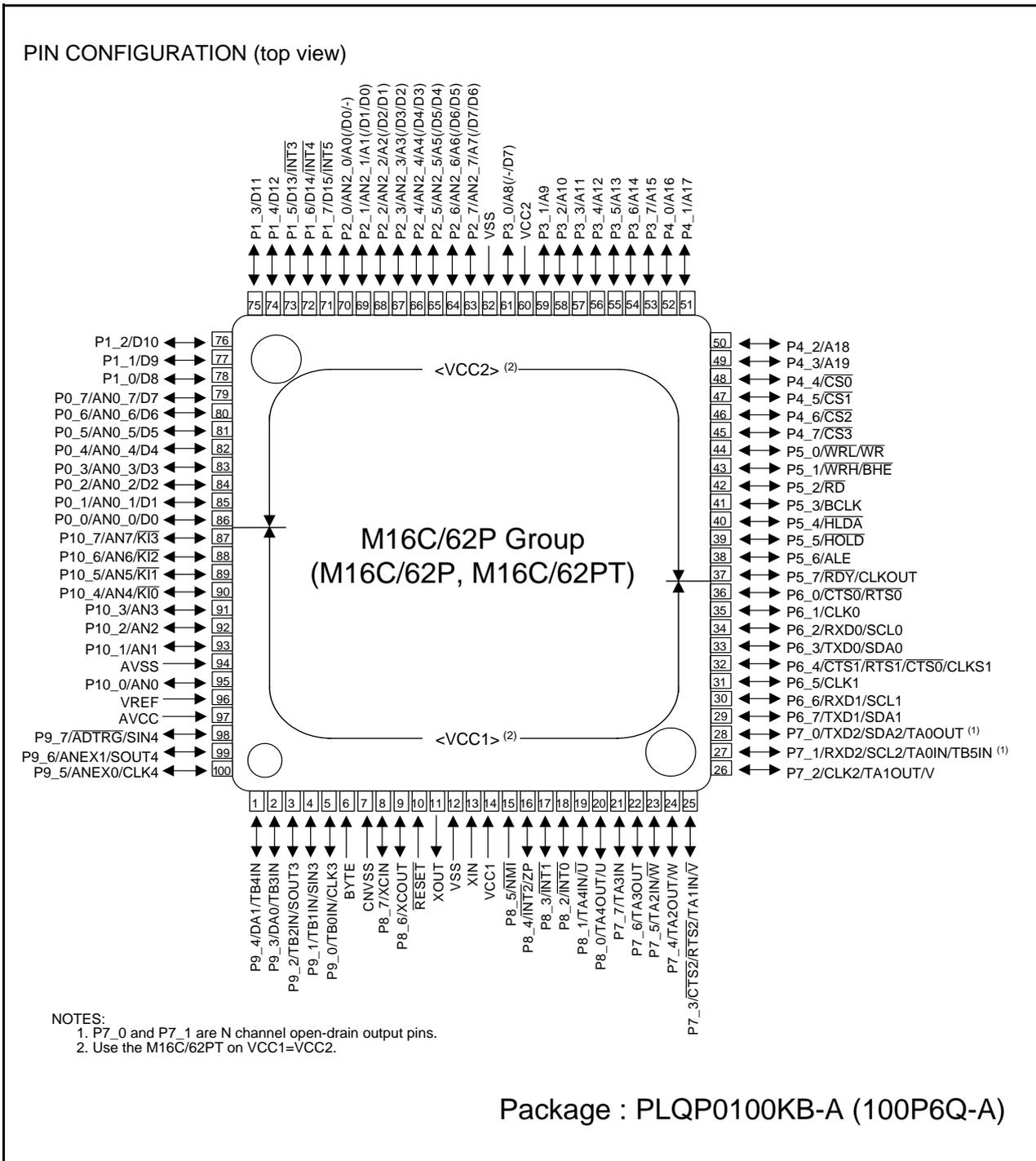


Figure 1.8 Pin Configuration (Top View)

**Table 1.14 Pin Characteristics for 100-Pin Package (2)**

Pin No.		Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	Bus Control Pin
FP	GP							
51	49		P4_3					A19
52	50		P4_2					A18
53	51		P4_1					A17
54	52		P4_0					A16
55	53		P3_7					A15
56	54		P3_6					A14
57	55		P3_5					A13
58	56		P3_4					A12
59	57		P3_3					A11
60	58		P3_2					A10
61	59		P3_1					A9
62	60	VCC2						
63	61		P3_0					A8(/-D7)
64	62	VSS						
65	63		P2_7				AN2_7	A7(/D7/D6)
66	64		P2_6				AN2_6	A6(/D6/D5)
67	65		P2_5				AN2_5	A5(/D5/D4)
68	66		P2_4				AN2_4	A4(/D4/D3)
69	67		P2_3				AN2_3	A3(/D3/D2)
70	68		P2_2				AN2_2	A2(/D2/D1)
71	69		P2_1				AN2_1	A1(/D1/D0)
72	70		P2_0				AN2_0	A0(/D0/-)
73	71		P1_7	$\overline{\text{INT5}}$				D15
74	72		P1_6	$\overline{\text{INT4}}$				D14
75	73		P1_5	$\overline{\text{INT3}}$				D13
76	74		P1_4					D12
77	75		P1_3					D11
78	76		P1_2					D10
79	77		P1_1					D9
80	78		P1_0					D8
81	79		P0_7				AN0_7	D7
82	80		P0_6				AN0_6	D6
83	81		P0_5				AN0_5	D5
84	82		P0_4				AN0_4	D4
85	83		P0_3				AN0_3	D3
86	84		P0_2				AN0_2	D2
87	85		P0_1				AN0_1	D1
88	86		P0_0				AN0_0	D0
89	87		P10_7	$\overline{\text{KI3}}$			AN7	
90	88		P10_6	$\overline{\text{KI2}}$			AN6	
91	89		P10_5	$\overline{\text{KI1}}$			AN5	
92	90		P10_4	$\overline{\text{KI0}}$			AN4	
93	91		P10_3				AN3	
94	92		P10_2				AN2	
95	93		P10_1				AN1	
96	94	AVSS						
97	95		P10_0				AN0	
98	96	VREF						
99	97	AVCC						
100	98		P9_7			SIN4	$\overline{\text{ADTRG}}$	

**Table 1.16 Pin Characteristics for 80-Pin Package (2)**

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Analog Pin	Bus Control Pin
51		P3_0					
52		P2_7				AN2_7	
53		P2_6				AN2_6	
54		P2_5				AN2_5	
55		P2_4				AN2_4	
56		P2_3				AN2_3	
57		P2_2				AN2_2	
58		P2_1				AN2_1	
59		P2_0				AN2_0	
60		P0_7				AN0_7	
61		P0_6				AN0_6	
62		P0_5				AN0_5	
63		P0_4				AN0_4	
64		P0_3				AN0_3	
65		P0_2				AN0_2	
66		P0_1				AN0_1	
67		P0_0				AN0_0	
68		P10_7	$\overline{KI3}$			AN7	
69		P10_6	$\overline{KI2}$			AN6	
70		P10_5	$\overline{KI1}$			AN5	
71		P10_4	$\overline{KI0}$			AN4	
72		P10_3				AN3	
73		P10_2				AN2	
74		P10_1				AN1	
75	AVSS						
76		P10_0				AN0	
77	VREF						
78	AVCC						
79		P9_7			SIN4	$\overline{ADTRG}$	
80		P9_6			SOUT4	ANEX1	

## 2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and logic/logic operations. A1 is the same as A0.

In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).

## 2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

## 2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

## 2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

## 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

## 2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

## 2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

### 2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

### 2.8.2 Debug Flag (D Flag)

The D flag is used exclusively for debugging purpose. During normal use, it must be set to "0".

### 2.8.3 Zero Flag (Z Flag)

This flag is set to "1" when an arithmetic operation resulted in 0; otherwise, it is "0".

### 2.8.4 Sign Flag (S Flag)

This flag is set to "1" when an arithmetic operation resulted in a negative value; otherwise, it is "0".

### 2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is "0"; register bank 1 is selected when this flag is "1".

### 2.8.6 Overflow Flag (O Flag)

This flag is set to "1" when the operation resulted in an overflow; otherwise, it is "0".

### 2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is "0", and are enabled when the I flag is "1". The I flag is cleared to "0" when the interrupt request is accepted.

## 4. Special Function Register (SFR)

SFR(Special Function Register) is the control register of peripheral functions. Tables 4.1 to 4.6 list the SFR information.

**Table 4.1 SFR Information (1) (1)**

Address	Register	Symbol	After Reset
0000h			
0001h			
0002h			
0003h			
0004h	Processor Mode Register 0 (2)	PM0	0000000b(CNVSS pin is "L") 0000011b(CNVSS pin is "H")
0005h	Processor Mode Register 1	PM1	00001000b
0006h	System Clock Control Register 0	CM0	01001000b
0007h	System Clock Control Register 1	CM1	00100000b
0008h	Chip Select Control Register (6)	CSR	00000001b
0009h	Address Match Interrupt Enable Register	AIER	XXXXXX00b
000Ah	Protect Register	PRCR	XX000000b
000Bh	Data Bank Register (6)	DBR	00h
000Ch	Oscillation Stop Detection Register (3)	CM2	0X000000b
000Dh			
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00XXXXXXb (4)
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h			00h
0012h			X0h
0013h			
0014h	Address Match Interrupt Register 1	RMAD1	00h
0015h			00h
0016h			X0h
0017h			
0018h			
0019h	Voltage Detection Register 1 (5, 6)	VCR1	00001000b
001Ah	Voltage Detection Register 2 (5, 6)	VCR2	00h
001Bh	Chip Select Expansion Control Register (6)	CSE	00h
001Ch	PLL Control Register 0	PLC0	0001X010b
001Dh			
001Eh	Processor Mode Register 2	PM2	XXX00000b
001Fh	Low Voltage Detection Interrupt Register (6)	D4INT	00h
0020h	DMA0 Source Pointer	SAR0	XXh
0021h			XXh
0022h			XXh
0023h			
0024h	DMA0 Destination Pointer	DAR0	XXh
0025h			XXh
0026h			XXh
0027h			
0028h	DMA0 Transfer Counter	TCR0	XXh
0029h			XXh
002Ah			
002Bh			
002Ch	DMA0 Control Register	DM0CON	00000X00b
002Dh			
002Eh			
002Fh			
0030h	DMA1 Source Pointer	SAR1	XXh
0031h			XXh
0032h			XXh
0033h			
0034h	DMA1 Destination Pointer	DAR1	XXh
0035h			XXh
0036h			XXh
0037h			
0038h	DMA1 Transfer Counter	TCR1	XXh
0039h			XXh
003Ah			
003Bh			
003Ch	DMA1 Control Register	DM1CON	00000X00b
003Dh			
003Eh			
003Fh			

NOTES:

1. The blank areas are reserved and cannot be accessed by users.
2. The PM00 and PM01 bits do not change at software reset, watchdog timer reset and oscillation stop detection reset.
3. The CM20, CM21, and CM27 bits do not change at oscillation stop detection reset.
4. The WDC5 bit is "0" (cold start) immediately after power-on. It can only be set to "1" in a program.
5. This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.
6. This register in M16C/62PT cannot be used.

X : Nothing is mapped to this bit

**Table 4.5 SFR Information (5) (1)**

Address	Register	Symbol	After Reset
0380h	Count Start Flag	TABSR	00h
0381h	Clock Prescaler Reset Fag	CPSRF	0XXXXXXb
0382h	One-Shot Start Flag	ONSF	00h
0383h	Trigger Select Register	TRGSR	00h
0384h	Up-Down Flag	UDF	00h (2)
0385h			
0386h	Timer A0 Register	TA0	XXh
0387h			XXh
0388h	Timer A1 Register	TA1	XXh
0389h			XXh
038Ah	Timer A2 Register	TA2	XXh
038Bh			XXh
038Ch	Timer A3 Register	TA3	XXh
038Dh			XXh
038Eh	Timer A4 Register	TA4	XXh
038Fh			XXh
0390h	Timer B0 Register	TB0	XXh
0391h			XXh
0392h	Timer B1 Register	TB1	XXh
0393h			XXh
0394h	Timer B2 Register	TB2	XXh
0395h			XXh
0396h	Timer A0 Mode Register	TA0MR	00h
0397h	Timer A1 Mode Register	TA1MR	00h
0398h	Timer A2 Mode Register	TA2MR	00h
0399h	Timer A3 Mode Register	TA3MR	00h
039Ah	Timer A4 Mode Register	TA4MR	00h
039Bh	Timer B0 Mode Register	TB0MR	00XX0000b
039Ch	Timer B1 Mode Register	TB1MR	00XX0000b
039Dh	Timer B2 Mode Register	TB2MR	00XX0000b
039Eh	Timer B2 Special Mode Register	TB2SC	XXXXXX00b
039Fh			
03A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
03A1h	UART0 Bit Rate Generator	U0BRG	XXh
03A2h	UART0 Transmit Buffer Register	U0TB	XXh
03A3h			XXh
03A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
03A5h	UART0 Transmit/Receive Control Register 1	U0C1	00XX0010b
03A6h	UART0 Receive Buffer Register	U0RB	XXh
03A7h			XXh
03A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
03A9h	UART1 Bit Rate Generator	U1BRG	XXh
03AAh	UART1 Transmit Buffer Register	U1TB	XXh
03ABh			XXh
03ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
03ADh	UART1 Transmit/Receive Control Register 1	U1C1	00XX0010b
03AEh	UART1 Receive Buffer Register	U1RB	XXh
03AFh			XXh
03B0h	UART Transmit/Receive Control Register 2	UCON	X0000000b
03B1h			
03B2h			
03B3h			
03B4h			
03B5h			
03B6h			
03B7h			
03B8h	DMA0 Request Factor Select Register	DM0SL	00h
03B9h			
03BAh	DMA1 Request Factor Select Register	DM1SL	00h
03BBh			
03BCh	CRC Data Register	CRCD	XXh
03BDh			XXh
03BEh	CRC Input Register	CRCIN	XXh
03BFh			

## NOTES:

1. The blank areas are reserved and cannot be accessed by users.
2. Bit 5 in the Up-down flag is "0" by reset. However, The values in these bits when read are indeterminate.

X : Nothing is mapped to this bit

**Table 5.2 Recommended Operating Conditions (1) (1)**

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
V <sub>CC1</sub> , V <sub>CC2</sub>	Supply Voltage (V <sub>CC1</sub> ≥ V <sub>CC2</sub> )		2.7	5.0	5.5	V
AV <sub>CC</sub>	Analog Supply Voltage			V <sub>CC1</sub>		V
V <sub>SS</sub>	Supply Voltage			0		V
AV <sub>SS</sub>	Analog Supply Voltage			0		V
V <sub>IH</sub>	HIGH Input Voltage	P3_1 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7	0.8V <sub>CC2</sub>		V <sub>CC2</sub>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (during single-chip mode)	0.8V <sub>CC2</sub>		V <sub>CC2</sub>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (data input during memory expansion and microprocessor mode)	0.5V <sub>CC2</sub>		V <sub>CC2</sub>	V
		P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1, XIN, $\overline{\text{RESET}}$ , CNVSS, BYTE	0.8V <sub>CC1</sub>		V <sub>CC1</sub>	V
		P7_0, P7_1	0.8V <sub>CC1</sub>		6.5	V
V <sub>IL</sub>	LOW Input Voltage	P3_1 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P12_0 to P12_7, P13_0 to P13_7	0		0.2V <sub>CC2</sub>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (during single-chip mode)	0		0.2V <sub>CC2</sub>	V
		P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 (data input during memory expansion and microprocessor mode)	0		0.16V <sub>CC2</sub>	V
		P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P14_0, P14_1, XIN, $\overline{\text{RESET}}$ , CNVSS, BYTE	0		0.2V <sub>CC</sub>	V
I <sub>OH(peak)</sub>	HIGH Peak Output Current	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1			-10.0	mA
I <sub>OH(avg)</sub>	HIGH Average Output Current	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_2 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1			-5.0	mA
I <sub>OL(peak)</sub>	LOW Peak Output Current	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1			10.0	mA
I <sub>OL(avg)</sub>	LOW Average Output Current	P0_0 to P0_7, P1_0 to P1_7, P2_0 to P2_7, P3_0 to P3_7, P4_0 to P4_7, P5_0 to P5_7, P6_0 to P6_7, P7_0 to P7_7, P8_0 to P8_4, P8_6, P8_7, P9_0 to P9_7, P10_0 to P10_7, P11_0 to P11_7, P12_0 to P12_7, P13_0 to P13_7, P14_0, P14_1			5.0	mA

## NOTES:

1. Referenced to V<sub>CC1</sub> = V<sub>CC2</sub> = 2.7 to 5.5V at T<sub>opr</sub> = -20 to 85°C / -40 to 85°C unless otherwise specified.
2. The Average Output Current is the mean value within 100ms.
3. The total I<sub>OL(peak)</sub> for ports P0, P1, P2, P8\_6, P8\_7, P9, P10, P11, P14\_0, and P14\_1 must be 80mA max. The total I<sub>OH(peak)</sub> for ports P0, P1, and P2 must be -40mA max. The total I<sub>OH(peak)</sub> for ports P3, P4, P5, P12, and P13 must be 80mA max. The total I<sub>OH(peak)</sub> for ports P6, P7, and P8\_0 to P8\_4 must be -40mA max. The total I<sub>OH(peak)</sub> for ports P8\_6, P8\_7, P9, P10, P14\_0, and P14\_1 must be -40mA max. Set Average Output Current to 1/2 of peak. The total I<sub>OH(peak)</sub> for ports P8\_6, P8\_7, P9, P10, P11, P14\_0, and P14\_1 must be -40mA max.  
As for 80-pin version, the total I<sub>OL(peak)</sub> for all ports and I<sub>OH(peak)</sub> must be 80mA. max. due to one V<sub>CC</sub> and one V<sub>SS</sub>.
4. There is no external connections for port P1\_0 to P1\_7, P4\_4 to P4\_7, P7\_2 to P7\_5 and P9\_1 in 80-pin version.

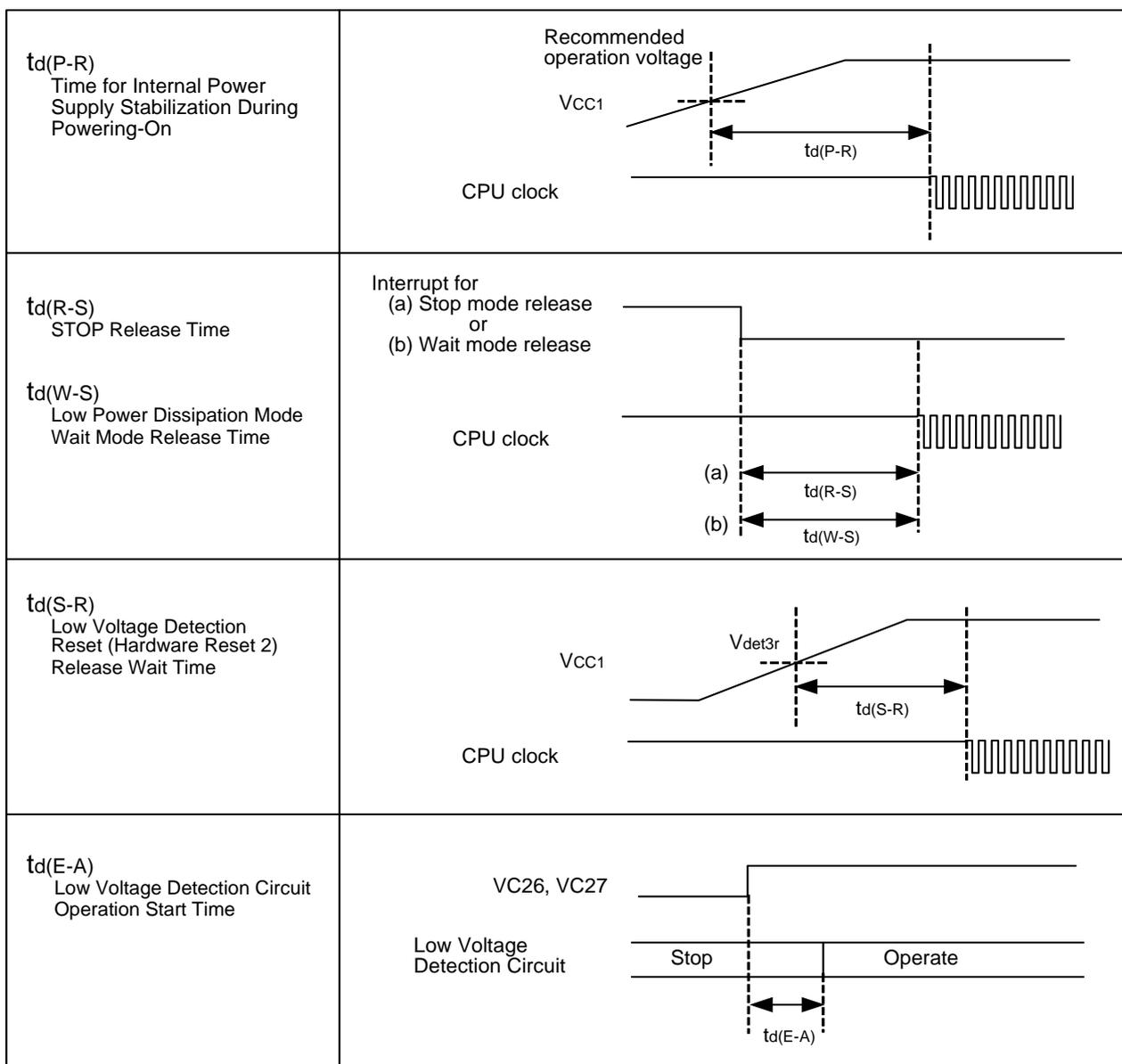
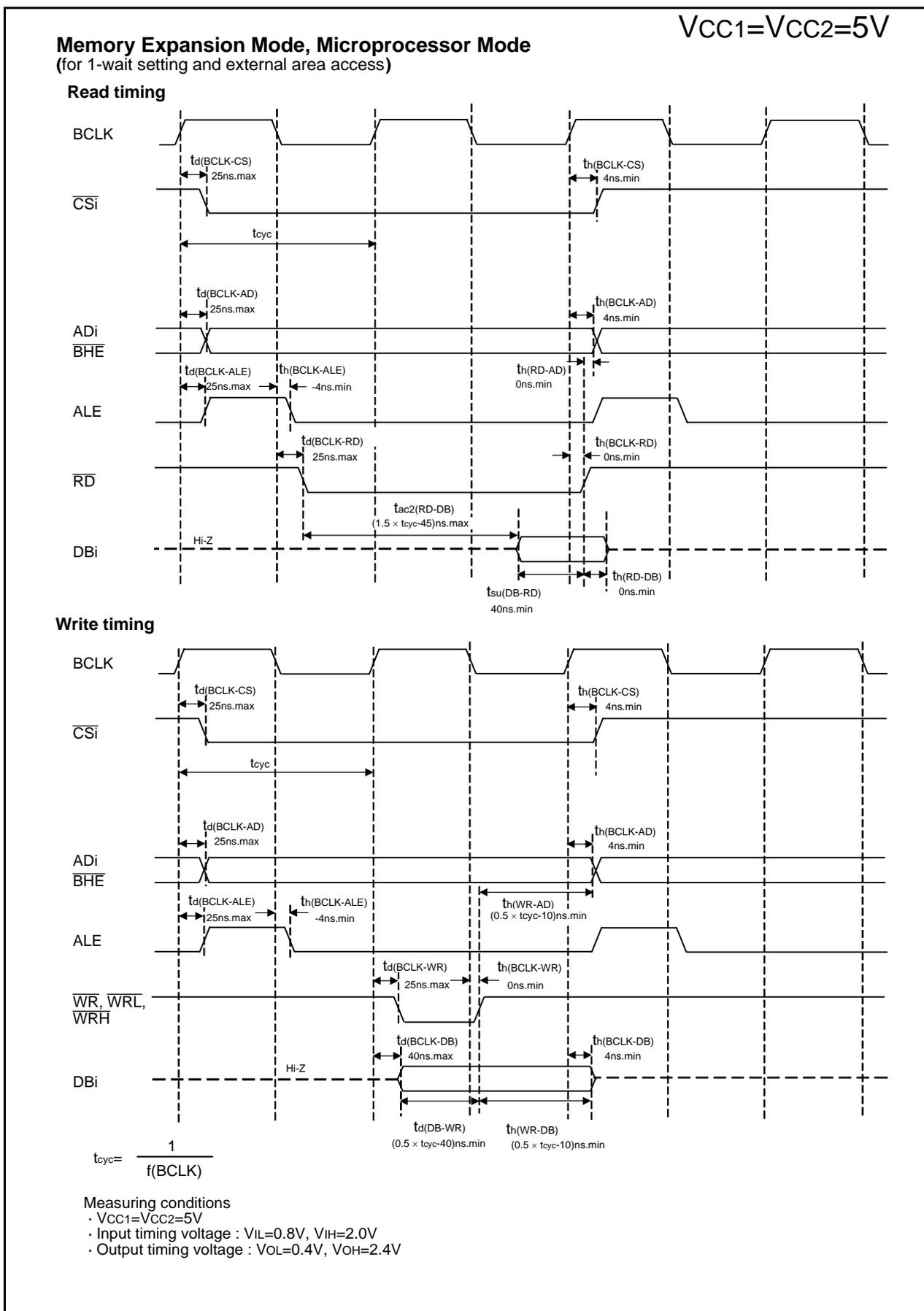


Figure 5.1 Power Supply Circuit Timing Diagram



**Figure 5.7 Timing Diagram (5)**

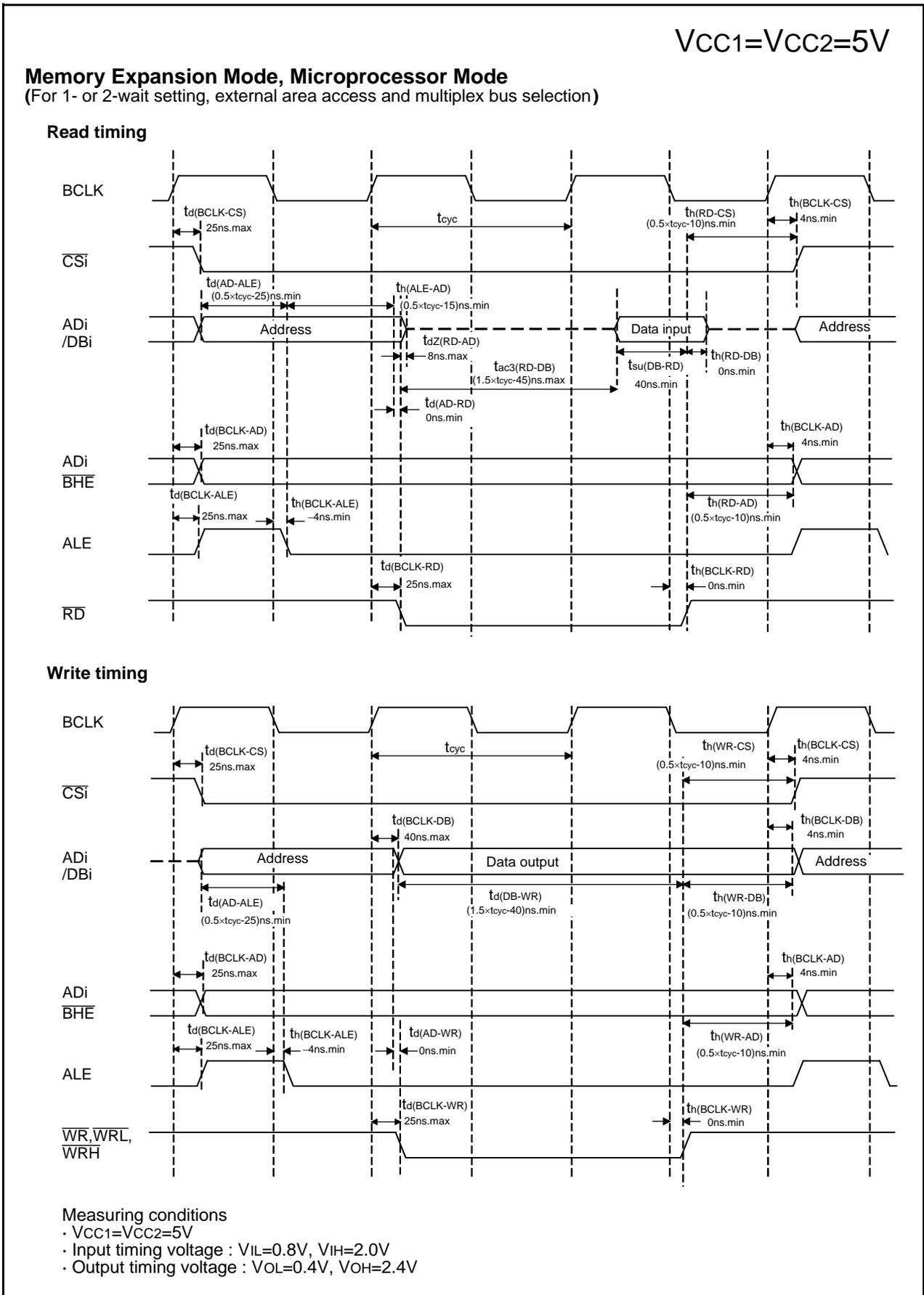


Figure 5.10 Timing Diagram (8)

$$V_{CC1}=V_{CC2}=3V$$

### Switching Characteristics

( $V_{CC1} = V_{CC2} = 5V$ ,  $V_{SS} = 0V$ , at  $T_{opr} = -20$  to  $85^{\circ}C$  /  $-40$  to  $85^{\circ}C$  unless otherwise specified)

**Table 5.47 Memory Expansion and Microprocessor Modes (for 1- to 3-wait setting and external area access)**

Symbol	Parameter		Standard		Unit
			Min.	Max.	
$t_{d(BCLK-AD)}$	Address Output Delay Time	See Figure 5.12		30	ns
$t_{h(BCLK-AD)}$	Address Output Hold Time (in relation to BCLK)		4		ns
$t_{h(RD-AD)}$	Address Output Hold Time (in relation to RD)		0		ns
$t_{h(WR-AD)}$	Address Output Hold Time (in relation to WR)		(NOTE 2)		ns
$t_{d(BCLK-CS)}$	Chip Select Output Delay Time			30	ns
$t_{h(BCLK-CS)}$	Chip Select Output Hold Time (in relation to BCLK)		4		ns
$t_{d(BCLK-ALE)}$	ALE Signal Output Delay Time			25	ns
$t_{h(BCLK-ALE)}$	ALE Signal Output Hold Time		-4		ns
$t_{d(BCLK-RD)}$	RD Signal Output Delay Time			30	ns
$t_{h(BCLK-RD)}$	RD Signal Output Hold Time		0		ns
$t_{d(BCLK-WR)}$	WR Signal Output Delay Time			30	ns
$t_{h(BCLK-WR)}$	WR Signal Output Hold Time		0		ns
$t_{d(BCLK-DB)}$	Data Output Delay Time (in relation to BCLK)			40	ns
$t_{h(BCLK-DB)}$	Data Output Hold Time (in relation to BCLK) <sup>(3)</sup>		4		ns
$t_{d(DB-WR)}$	Data Output Delay Time (in relation to WR)		(NOTE 1)		ns
$t_{h(WR-DB)}$	Data Output Hold Time (in relation to WR) <sup>(3)</sup>		(NOTE 2)		ns
$t_{d(BCLK-HLDA)}$	HLDA Output Delay Time		40	ns	

#### NOTES:

1. Calculated according to the BCLK frequency as follows:

$$\frac{(n-0.5) \times 10^9}{f(\text{BCLK})} - 40[\text{ns}]$$

n is "1" for 1-wait setting, "2" for 2-wait setting and "3" for 3-wait setting.  
(BCLK) is 12.5MHz or less.

2. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 10[\text{ns}]$$

3. This standard value shows the timing when the output is off, and does not show hold time of data bus.

Hold time of data bus varies with capacitor volume and pull-up (pull-down) resistance value.

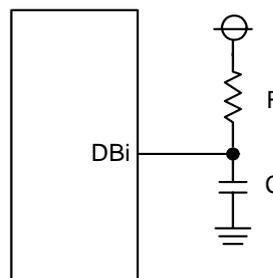
Hold time of data bus is expressed in

$$t = -CR \times \ln(1 - V_{OL} / V_{CC2})$$

by a circuit of the right figure.

For example, when  $V_{OL} = 0.2V_{CC2}$ ,  $C = 30\text{pF}$ ,  $R = 1\text{k}\Omega$ , hold time of output "L" level is

$$t = -30\text{pF} \times 1\text{k}\Omega \times \ln(1 - 0.2V_{CC2} / V_{CC2}) = 6.7\text{ns}.$$



$$V_{CC1}=V_{CC2}=3V$$

### Switching Characteristics

( $V_{CC1} = V_{CC2} = 5V$ ,  $V_{SS} = 0V$ , at  $T_{opr} = -20$  to  $85^{\circ}C$  /  $-40$  to  $85^{\circ}C$  unless otherwise specified)

**Table 5.48 Memory Expansion and Microprocessor Modes (for 2- to 3-wait setting, external area access and multiplex bus selection)**

Symbol	Parameter		Standard		Unit
			Min.	Max.	
$t_d(\text{BCLK-AD})$	Address Output Delay Time	See Figure 5.12		50	ns
$t_h(\text{BCLK-AD})$	Address Output Hold Time (in relation to BCLK)		4		ns
$t_h(\text{RD-AD})$	Address Output Hold Time (in relation to RD)		(NOTE 1)		ns
$t_h(\text{WR-AD})$	Address Output Hold Time (in relation to WR)		(NOTE 1)		ns
$t_d(\text{BCLK-CS})$	Chip Select Output Delay Time			50	ns
$t_h(\text{BCLK-CS})$	Chip Select Output Hold Time (in relation to BCLK)		4		ns
$t_h(\text{RD-CS})$	Chip Select Output Hold Time (in relation to RD)		(NOTE 1)		ns
$t_h(\text{WR-CS})$	Chip Select Output Hold Time (in relation to WR)		(NOTE 1)		ns
$t_d(\text{BCLK-RD})$	RD Signal Output Delay Time			40	ns
$t_h(\text{BCLK-RD})$	RD Signal Output Hold Time		0		ns
$t_d(\text{BCLK-WR})$	WR Signal Output Delay Time			40	ns
$t_h(\text{BCLK-WR})$	WR Signal Output Hold Time		0		ns
$t_d(\text{BCLK-DB})$	Data Output Delay Time (in relation to BCLK)			50	ns
$t_h(\text{BCLK-DB})$	Data Output Hold Time (in relation to BCLK)		4		ns
$t_d(\text{DB-WR})$	Data Output Delay Time (in relation to WR)		(NOTE 2)		ns
$t_h(\text{WR-DB})$	Data Output Hold Time (in relation to WR)		(NOTE 1)		ns
$t_d(\text{BCLK-HLDA})$	HLDA Output Delay Time			40	ns
$t_d(\text{BCLK-ALE})$	ALE Signal Output Delay Time (in relation to BCLK)			25	ns
$t_h(\text{BCLK-ALE})$	ALE Signal Output Hold Time (in relation to BCLK)		-4		ns
$t_d(\text{AD-ALE})$	ALE Signal Output Delay Time (in relation to Address)		(NOTE 3)		ns
$t_h(\text{AD-ALE})$	ALE Signal Output Hold Time (in relation to Address)		(NOTE 4)		ns
$t_d(\text{AD-RD})$	RD Signal Output Delay From the End of Address		0		ns
$t_d(\text{AD-WR})$	WR Signal Output Delay From the End of Address		0		ns
$t_{dz}(\text{RD-AD})$	Address Output Floating Start Time			8	ns

#### NOTES:

1. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 10[\text{ns}]$$

2. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 50[\text{ns}] \quad n \text{ is "2" for 2-wait setting, "3" for 3-wait setting.}$$

3. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 40[\text{ns}]$$

4. Calculated according to the BCLK frequency as follows:

$$\frac{0.5 \times 10^9}{f(\text{BCLK})} - 15[\text{ns}]$$

**Table 5.58 Electrical Characteristics (2) (1)**

Symbol	Parameter		Measuring Condition		Standard			Unit
					Min.	Typ.	Max.	
I <sub>cc</sub>	Power Supply Current (V <sub>cc1</sub> =V <sub>cc2</sub> =4.0V to 5.5V)	In single-chip mode, the output pins are open and other pins are V <sub>ss</sub>	Mask ROM	f(BCLK)=24MHz No division, PLL operation		14	20	mA
				No division, On-chip oscillation		1		mA
			Flash Memory	f(BCLK)=24MHz, No division, PLL operation		18	27	mA
				No division, On-chip oscillation		1.8		mA
			Flash Memory Program	f(BCLK)=10MHz, V <sub>cc1</sub> =5.0V		15		mA
			Flash Memory Erase	f(BCLK)=10MHz, V <sub>cc1</sub> =5.0V		25		mA
			Mask ROM	f(XCIN)=32kHz Low power dissipation mode, ROM (3)		25		μA
			Flash Memory	f(BCLK)=32kHz Low power dissipation mode, RAM (3)		25		μA
				f(BCLK)=32kHz Low power dissipation mode, Flash Memory (3)		420		μA
				On-chip oscillation, Wait mode		50		μA
			Mask ROM Flash Memory	f(BCLK)=32kHz Wait mode (2), Oscillation capability High		7.5		μA
				f(BCLK)=32kHz Wait mode (2), Oscillation capability Low		2.0		μA
				Stop mode T <sub>opr</sub> =25°C		2.0	6.0	μA
				Stop mode T <sub>opr</sub> =85°C			20	μA
Stop mode T <sub>opr</sub> =125°C				TBD	μA			

## NOTES:

1. Referenced to V<sub>cc1</sub>=V<sub>cc2</sub>=4.0 to 5.5V, V<sub>ss</sub> = 0V at T<sub>opr</sub> = -40 to 85°C / -40 to 125°C, f(BCLK)=24MHz unless otherwise specified. T version = -40 to 85°C, V version = -40 to 125°C.
2. With one timer operated using fC32.
3. This indicates the memory in which the program to be executed exists.

$$V_{CC1}=V_{CC2}=5V$$

**Timing Requirements**

( $V_{CC1} = V_{CC2} = 5V$ ,  $V_{SS} = 0V$ , at  $T_{opr} = -40$  to  $85^{\circ}C$  (T version) /  $-40$  to  $125^{\circ}C$  (V version) unless otherwise specified)

**Table 5.60 Timer A Input (Counter Input in Event Counter Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	100		ns
$t_{w(TAH)}$	TAiIN Input HIGH Pulse Width	40		ns
$t_{w(TAL)}$	TAiIN Input LOW Pulse Width	40		ns

**Table 5.61 Timer A Input (Gating Input in Timer Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	400		ns
$t_{w(TAH)}$	TAiIN Input HIGH Pulse Width	200		ns
$t_{w(TAL)}$	TAiIN Input LOW Pulse Width	200		ns

**Table 5.62 Timer A Input (External Trigger Input in One-shot Timer Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	200		ns
$t_{w(TAH)}$	TAiIN Input HIGH Pulse Width	100		ns
$t_{w(TAL)}$	TAiIN Input LOW Pulse Width	100		ns

**Table 5.63 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(TAH)}$	TAiIN Input HIGH Pulse Width	100		ns
$t_{w(TAL)}$	TAiIN Input LOW Pulse Width	100		ns

**Table 5.64 Timer A Input (Counter Increment/Decrement Input in Event Counter Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(UP)}$	TAiOUT Input Cycle Time	2000		ns
$t_{w(UPH)}$	TAiOUT Input HIGH Pulse Width	1000		ns
$t_{w(UPL)}$	TAiOUT Input LOW Pulse Width	1000		ns
$t_{su(UP-TIN)}$	TAiOUT Input Setup Time	400		ns
$t_{h(TIN-UP)}$	TAiOUT Input Hold Time	400		ns

**Table 5.65 Timer A Input (Two-phase Pulse Input in Event Counter Mode)**

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAiIN Input Cycle Time	800		ns
$t_{su(TAIN-TAOUT)}$	TAiOUT Input Setup Time	200		ns
$t_{su(TAOUT-TAIN)}$	TAiIN Input Setup Time	200		ns